



Product Change Notification

Change Notification #: 117118 - 00
Change Title: Adding Desiccant Pouch for small shipping box,
PCN 117118-00, Transport Media,
Adding Additional Desiccant Pouch for small shipping box for Tray products only
Date of Publication: August 16, 2019

Key Characteristics of the Change:

Transport Media

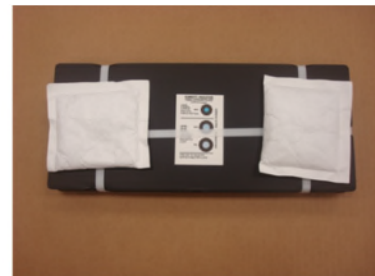
Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	September 15, 2019
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Description of Change to the Customer:

In order to address the marginality of coloration displayed on the Humidity Indicator Card (HIC) of desiccant packed products, Intel will be adding an additional desiccant pouch. The additional desiccant pouch is exclusively for all products that are Tray packed and shipped in a small box.

As a result of adding the additional desiccant pouch, the placement of the HIC will be moved to a new location. For Tray stacks, the desiccant pouches will be placed at each end and the HIC will be placed in the middle.



Customer Impact of Change and Recommended Action:

There is no change to the form, fit, or function of the product due to this change. Customers should, however, notify their inbound shipping/receiving personnel who may open up packaged materials and ensure they are aware of the change.

Intel will deplete older packaged material currently on shelves containing only the single desiccant pouch during the transition and therefore customers should expect to see a mix of packaging options until older packaged material has been depleted.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

The change will apply to all Tray packed parts. In short, if products today are being shipped in Tray media in a small box and include a desiccant pouch, customers will now see the use of two desiccant pouches instead of one, with the HIC placed in the middle.

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
August 16, 2019	00	Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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